

### Part Number: XZCBD80S-2HTA

2.2x1.4mm SURFACE MOUNT LED LAMP

#### **Features**

• Ideal for indication light on hand held products

www.SunLEDusa.com

- Long life and robust package
- Variety of lens types and color choices available
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant

## **Applications**

- Backlighting for tell-tale indicators
- Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating

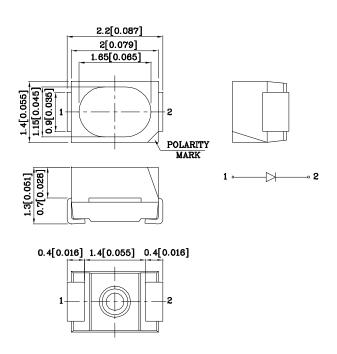


ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES



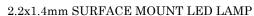


# **Package Schematics**



### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- $3. \ {\rm Specifications}$  are subject to change without notice.





### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

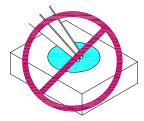
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

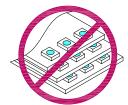


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

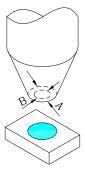




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



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2.2x1.4mm SURFACE MOUNT LED LAMP



Part Number	Dice	Lens-color	Luminous Intensity CIE127-2007* (IF=20mA) mcd			Viewing Angle 20 1/2[1]
			Code.	min.	max.	
			M*	80*	120*	
XZCBD80S-2HTA	Blue (InGaN)	Water Clear	N*	120*	200*	120°
			P*	200*	300*	

#### Note:

# Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	PD	80	mW
Reverse Voltage	VR	5	V
Junction temperature[1]	TJ	115	°C
Operating Temperature	Тор	-40 To +100	°C
Storage Temperature	Tstg	-40 To +110	°C
DC Forward Current[1]	IF	20	mA
Peak Forward Current [2]	IFM	150	mA
Electrostatic Discharge Threshold (HBM)	250	V	
Thermal Resistance (Junction/ambient) [1]	Rth j-a	570	°C/W

#### Notes:

# Electrical / Optical Characteristics at Ta=25°C

Donomoton	Symbol	Value				TT **
Parameter		Code.	Min.	Typ.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF=20mA	λpeak			460*		nm
		1B*	463*		466*	
	λdom [1]	2A*	466*		469*	
Dominant Wavelength CIE127-2007* IF=20mA		2B*	469*		471*	nm
		3A*	471*		473*	
		3B*	473*		475*	
Spectral bandwidth at 50%Φ REL MAX IF=20mA [Typ.]	Δλ			25		nm
Forward Voltage IF=20mA	VF [2]			3.3	4.0	V
Reverse Current (VR = 5V)	IR				50	uA
Temperature coefficient of λpeak IF=20mA, -10°C≤ T≤100°C [Typ.]	TCλpeak			0.05		nm/°C
Temperature coefficient of λdom I <sub>F</sub> =20mA, -10°C≤ T≤100°C [Typ.]	TCλdom			0.03		nm/°C
Temperature coefficient of VF IF=20mA, -10°C≤ T≤100°C	TCv			-2.5		mV/°C

<sup>\*</sup>Wavelength value is in accordance with CIE127-2007 standards.

 $<sup>1. \</sup>theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

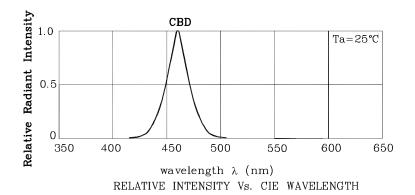
<sup>\*</sup> luminous intensity value is in accordance with CIE127-2007 standards.

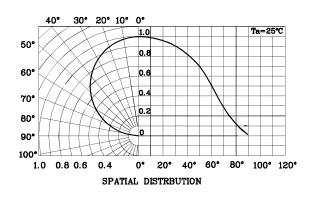
<sup>1.</sup> Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),

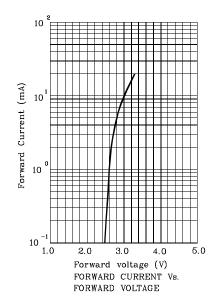
<sup>2. 1/10</sup> Duty Cycle, 0.1ms Pulse Width.

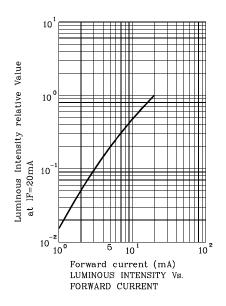


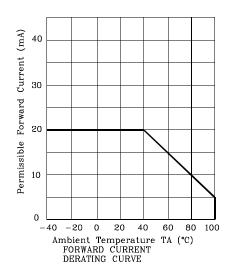


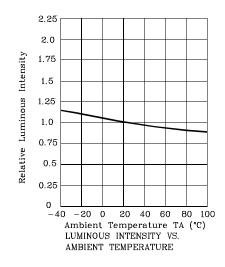










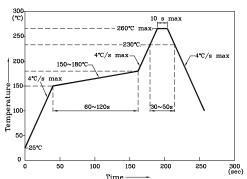






# LED is recommended for reflow soldering and soldering profile is shown below.

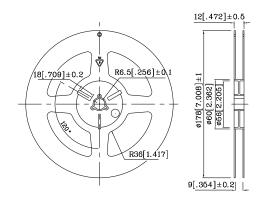
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

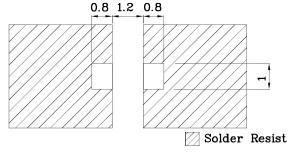
  1. Maximum soldering temperature should not exceed 260°c.
  - 2. Recommended reflow temperature: 145°c-260°c.
  - 3. Do not put stress to the epoxy resin during high

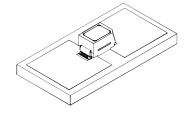
## **Reel Dimension**



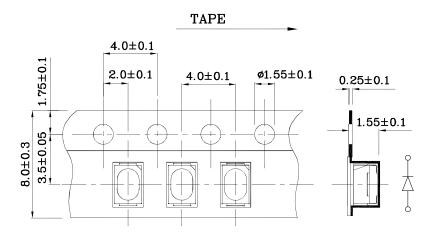
# **Recommended Soldering Pattern** (Units: mm; Tolerance: ±0.1)

❖ The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

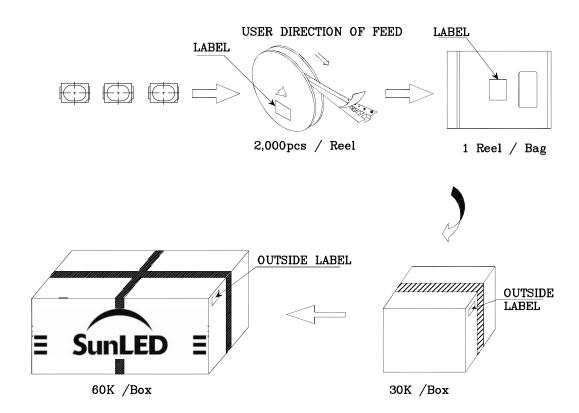
Note: Accuracy may depend on the sorting parameters.

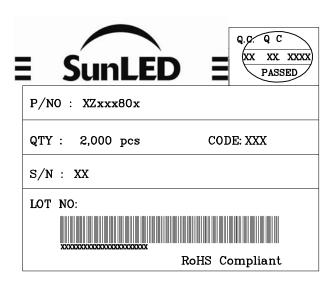
XDSB6460 Nov 20,2013 V2-ZLayout: Maggie





#### PACKING & LABEL SPECIFICATIONS





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# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below

Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	Ta =25°C ,IF = maximum rated current*	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100 (101)	Ta = 100°C IF = derated current at 100°C	1,000 h	0 / 22
3	Low Temp. operating test	-	Ta = -40°C, IF = maximum rated current*	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100 (201)	Ta = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100 (202)	Ta = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	-	Ta = 60°C, RH = 90%	500 h	0 / 22
7	High temp. & humidity operating test	-	Ta = 60°C, RH = 90% IF = derated current at 60°C	500 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100 (301)	Moisture soak : 30°C,70% RH, 72h Preheat : 150~180°C(120s max.) Soldering temp : 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	Ta = -40°C(15min) ~ 100°C(15min) IF = derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	Ta = -40°C(15min) ~ 100°C(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100 (304)	$C = 100 pF$ , $R2 = 1.5 K\Omega$ $V = 250 V$	Once each Polarity	0 / 22
12	Vibration test	-	$a = 196 \text{m/s}^2$ , $f = 100 \sim 2 \text{KHz}$ , t = 48 min for all xyz axes	4 times	0 / 22

<sup>\*:</sup> Refer to forward current vs. derating curve diagram

## Failure Criteria

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	$I_F = 20 \text{mA}$	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	$I_F = 20 \text{mA}$	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	_	Occurrence of notable decoloration, deformation and cracking